Multilayer Ceramic Chip Capacitors

C1608CH1H090C080AA



TDK item description C1608CH1H090CT****

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Dimensions in n

	Size
Length(L)	1.60mm ±0.10mm
Width(W)	0.80mm ±0.10mm
Thickness(T)	0.80mm ±0.10mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)
	0.60mm to 0.80mm(Reflow Soldering)

Electrical Characteristics		
Capacitance	9pF ±0.25pF	
Rated Voltage	50VDC	
Temperature Characteristic	CH(0±60ppm/°C)	
Q (Min.)	580	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Wave (Flow)
	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	4000pcs

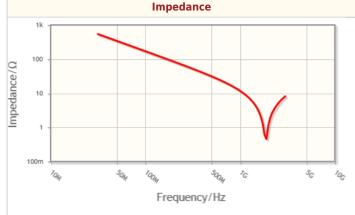
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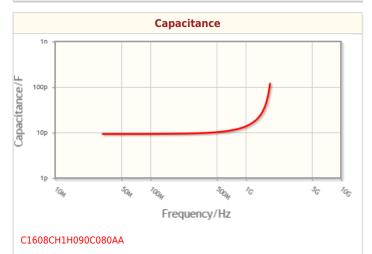
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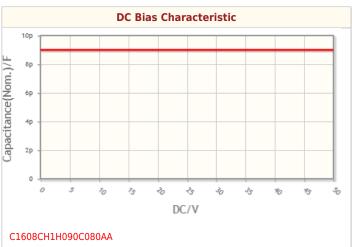




Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

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Temperature Characteristic 9.01p Capacitance(Nom.)/F 9.005p 9p 8.995p 8.99p ~b 0 r в ъ б :20 'To Temperature/degC C1608CH1H090C080AA(DC Bias = 25V) C1608CH1H090C080AA(No Bias)

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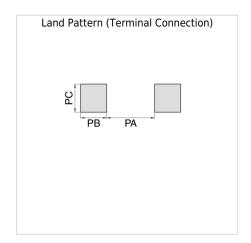
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Associated Images



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